

# Technical Information

ModSTACK™ 6MS1200R17KE3-3F-B16B9C23VTIO



**Vorläufige Daten**  
preliminary data

## Key data

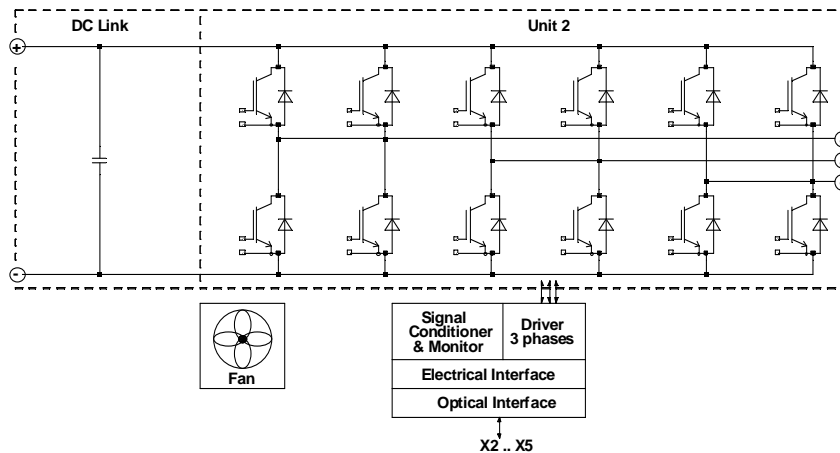
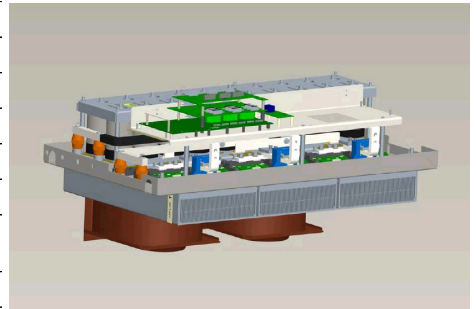
3x 663A rms at 690V rms, forced air (fan included)

## General information

Stacks for various inverter application. Semiconductors, heat sinks, capacitors, drivers and sensors included. These are only technical data!

Please read carefully the complete documentation and maintain the proper design environment! Especially note the EMC environment and the controller's functionality.

Topology	DC Link + B6I	
Application / Modulation	Inverter / Sine	
Load type	resistive, inductive	
Cooling	forced air (fan included)	
Market	wind	
Implemented sensors	current, voltage, temperature	
Semicond. (Unit 1)	none	
DC Link	8.4mF	
Semicond. (Unit 2)	IGBT	6x FF600R17KE3_B2
Driver signals IGBT	optical HFBR-15X1 / HFBR-25X1	
Standards	EN50178	
Sales - name	6MS12017E33F33879	
Internal ID	33879	
Mechanical drawing number	33878_MB	
Electrical drawing number	ModSTACK B6_01_OEA101_Rev03	
Dimensions (width x depth x height)	1090 mm x 596 mm x 470 mm	
Weight	110 kg	



prepared by: Hoelbe Oliver	date of publication: 2009-08-20
approved by: Jürgen Schiele	revision: 2.0

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### Electrical data

#### DC Link

			min	typ	max	units
Voltage		$V_{DC}$		1100	1200	V
Oversvoltage shutdown	within 150µs			1250		V

#### Unit 2 AC

			min	typ	max	units
Voltage	depending on controller	$V_{Unit2}$		690		$V_{RMS}$
Continuous current	$V_{Unit2} = 690V_{RMS}$ , $V_{DC} = 1100V$ , $T_{inlet} = 40^{\circ}C$ , $T_J \leq 125^{\circ}C$ , $f_{Unit2} = 50Hz$ , $f_{sw2} = 2000Hz$ , $\cos(\phi) = 0,99$	$I_{Unit2}$			663	$A_{RMS}$
Continuous current overload cap.	$T_{inlet} = 40^{\circ}C$ , for overload capability 150% for 60s			476		$A_{RMS}$
Short time current	$T_{inlet} = 40^{\circ}C$ , 10s, every 180s, initial load = 588 $A_{RMS}$	$I_{Unit2}$			735	$A_{RMS}$
DC current	no rotating field, $T_{inlet} = 40^{\circ}C$	$I_{Unit2 DC}$			291,0	$A_{av}$
Overcurrent shutdown	within 15µs			1300		$A_{peak}$
Switching frequency		$f_{sw2}$			6000	Hz
Power losses	$V_{Unit2} = 690V$ , $V_{DC} = 1100V$ , $T_{inlet} = 40^{\circ}C$ , $T_J \leq 125^{\circ}C$ , $f_{Unit2} = 50Hz$ , $f_{sw2} = 2000Hz$ , $\cos(\phi) = -0,99$ , $I_{Unit2} = 663A_{RMS}$	$P_{loss2}$		8260		W
Power factor		$\cos(\phi)_{Unit2}$	-1,00		1,00	

#### General data

			min	typ	max	units
Power losses (PCB and capacitor)		$P_{loss aux}$			220	W
EMC test	according to IEC61800-3 at named interfaces	power	$V_{Burst}$	2		kV
		control	$V_{Burst}$	1		kV
		aux (24V)	$V_{Surge}$	1		kV
Insulation management is designed for		$V_{Line}$		690		$V_{RMS}$
Insulation test voltage	according to EN50178, $f = 50Hz$ , $t = 60s$	$V_{isol}$		2,5		kV $_{RMS}$

#### Important component data

			min	typ	max	units
DC Link capacitor		$C_{DC}$		8,40		mF
		type		Foil		
Rated voltage	per device	$U_R$		1100		$V_{DC}$
Surge voltage	per device	$U_{Surge}$			1650	V
Rated capacitance	per device	$C_R$		420		µF
Capacitance tolerance	per device	Tol	-15		0	%
wiring system	series, parallel			1s, 20p		
Balance or discharge resistors	per DC Link unit	$R_b$		6,0		kΩ

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### Controller interface data

			min	typ	max	units
Auxiliary voltage		$V_{aux}$	18	24	30	$V_{av}$
Auxiliary power requirement	$V_{aux} = 24V_{av}$	$P_{aux}$	40			W
Driver and interface board	see separate technical information		TR110 / DR110			
Driver core			EiceDRIVER 2ED300C17-S			
Digital input level	resistor to GND 1,8k $\Omega$ , capacitor to GND 4nF, high = on, min 15mA	$V_{in}$	0,0		15,0	V
Digital output level	open collector, low = ok, max 15mA	$V_{out}$	0,0		15,0	V
Analog current outputs Unit 2	load max 1mA; at 663A	$V_{ana\ out}$	4,36	4,45	4,54	V
Analog DC Link voltage output	load max 1mA; at 1100V	$V_{DC\ out}$	7,73	7,89	8,05	V
Analog temperature output	load max 1mA; at $T_{NTC} = 80^{\circ}C$ correspond to $T_j = 125^{\circ}C$	$V_{T\ out}$	9,70	9,90	10,10	V
Overtemperature shutdown	at $T_{NTC} = 81^{\circ}C$ correspond to $T_j = 130^{\circ}C$	$V_{T\ out\ OT}$		10		V
Optical interface board	see separate technical information		OEA101			
Optical input power				12		$\mu W$
Optical output power					60	$\mu W$

### Heat sink air cooled / Thermal data

			min	typ	max	units
Airflow	$T_{Air} = 20^{\circ}C$ , Pair = 1013hPa, dry- and dust free, measured on side of heat sink. according to DIN 41882	$\Delta V / \Delta t_{Air}$	2700			m <sup>3</sup> /h
Air pressure drop		$\Delta p_{Air}$		300		Pa
Cooling air inlet temperature	heat sink temperature > -25 $^{\circ}C$	$T_{inlet}$	-25		40	$^{\circ}C$

### Fan data

			min	typ	max	units
Type	assumed		2x Ziehl-Abegg. RF22P-2DK.3F.1R			
Voltage		$V_{Fan}$		400		$V_{RMS}$
Frequency		$f_{Fan}$		50		Hz
Current		$I_{Fan}$		3,90		$A_{RMS}$

### IGBT data unit 2

			min	typ	max	units
Type	assumed					
collector-emitter saturation voltage	$I_c = 600A$ ; $V_{ge} = 15V$ ; $T_{vj} = 125^{\circ}C$	$V_{CE\ sat}$		2,4		V
parameter for linear model	$T_{vj} = 25^{\circ}C$	$V_{ce1}$		1,07		V
parameter for linear model	$T_{vj} = 25^{\circ}C$	$r_{ce1}$		1,55		m $\Omega$
parameter for linear model	$T_{vj} = 125^{\circ}C$	$V_{ce2}$		1,02		V
parameter for linear model	$T_{vj} = 125^{\circ}C$	$r_{ce2}$		2,3		m $\Omega$
turn-on / turn-off energy loss per pulse	$T_{vj} = 25^{\circ}C$	$E_1$		125 / 150		mJ
turn-on / turn-off energy loss per pulse	$T_{vj} = 125^{\circ}C$	$E_2$		185 / 220		mJ
thermal resistance, junction to case	per IGBT	$R_{thjc}$		0,029		K/W
thermal resistance, case to heatsink	per IGBT	$R_{thch}$		0,024		K/W

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### Diode data unit 2

			min	typ	max	units
Type	assumed					
forward voltage	$I_F = 600A; V_{ge} = 0V; T_{vj} = 125^\circ C$	$V_F$		1,7		V
parameter for linear model	$T_{vj} = 25^\circ C$	$V_{F1}$		1,09		V
parameter for linear model	$T_{vj} = 25^\circ C$	$r_{F1}$		0,85		mΩ
parameter for linear model	$T_{vj} = 125^\circ C$	$V_{F2}$		0,89		V
parameter for linear model	$T_{vj} = 125^\circ C$	$r_{F2}$		1,35		mΩ
reverse recovery energy	$T_{vj} = 25^\circ C$	$E_{rec1}$		120		mJ
reverse recovery energy	$T_{vj} = 125^\circ C$	$E_{rec2}$		210		mJ
thermal resistance, junction to case	per Diode	$R_{thjc}$		0,055		K/W
thermal resistance, case to heatsink	per Diode	$R_{thch}$		0,046		K/W

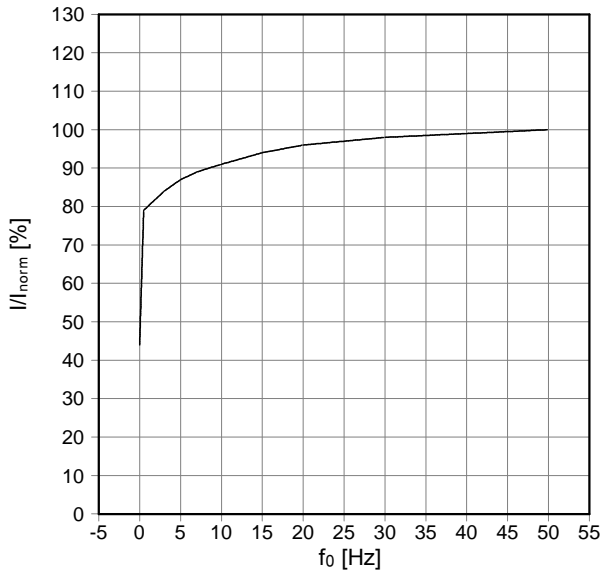
### Environmental conditions

			min	typ	max	units
Storage temperature		$T_{stor}$	-40		65	°C
Ambient temperature	minimum 0°C for optional optical interface	$T_{amb}$	-25		55	°C
Operating temperature	see chapter Heat sink air cooled / Thermal data					
Cooling air velocity (PCB and capacitor)		$V_{Air PCB}$	2,0			m/s
Air pressure	standard atmosphere	$p_{Air}$	900		1100	hPa
Humidity	no condensation	Rel. F	0		95	%
Installation height			0		1000	m
Vibration	according to EN60068				10	m/s <sup>2</sup>
Continuous vibration	according to EN60068				20	m/s <sup>2</sup>
Shock	according to EN60068				100	m/s <sup>2</sup>
Protection degree			IP00			
Pollution degree			2			
Dimensions	width × depth × height		1090	596	470	mm
Weight with heat sink	approximation			110,0		kg

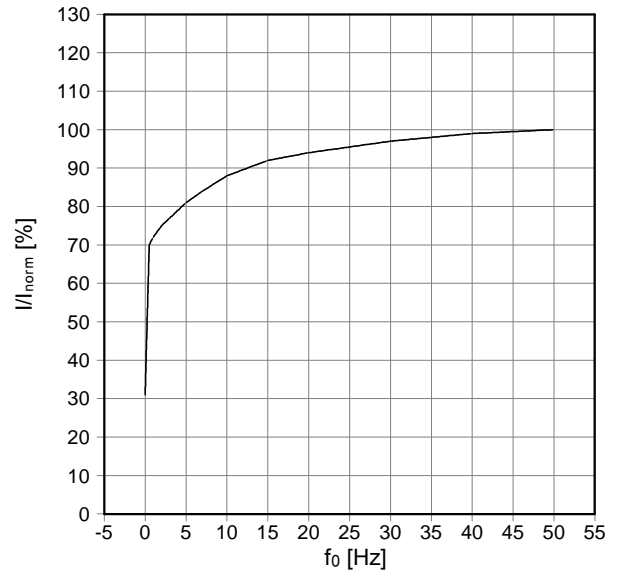
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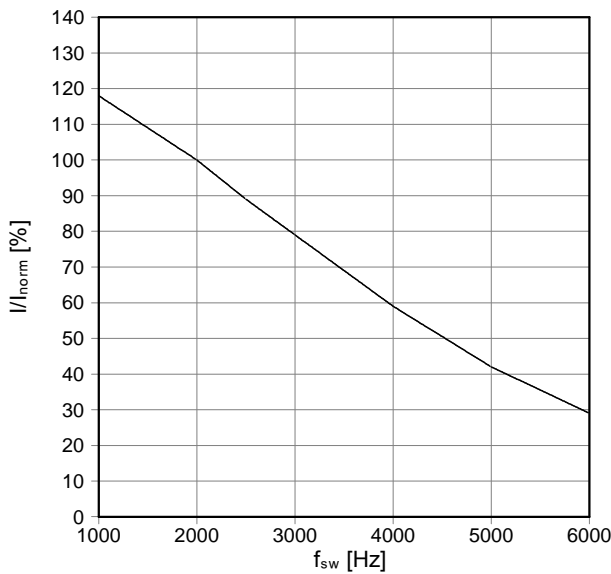
fo - derating curve IGBT (motor)  
cos(phi) = 0,99  
T<sub>cool medium</sub> = 40°C ; 100% = 663 A rms



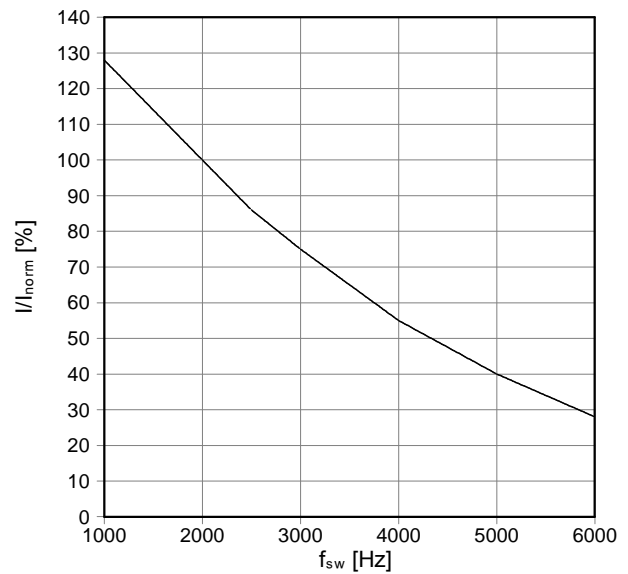
fo - derating curve Diode (generator)  
cos(phi) = -0,99  
T<sub>cool medium</sub> = 40°C ; 100% = 636 A rms



fsw - derating curve IGBT (motor)  
cos(phi) = 0,99  
T<sub>cool medium</sub> = 40°C ; 100% = 663 A rms



fsw - derating curve Diode (generator)  
Diode, cos(phi) = -0,99  
T<sub>cool medium</sub> = 40°C ; 100% = 636 A rms



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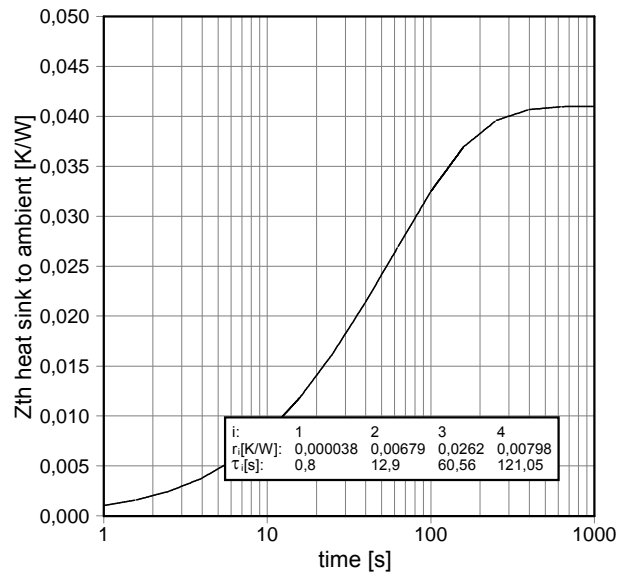
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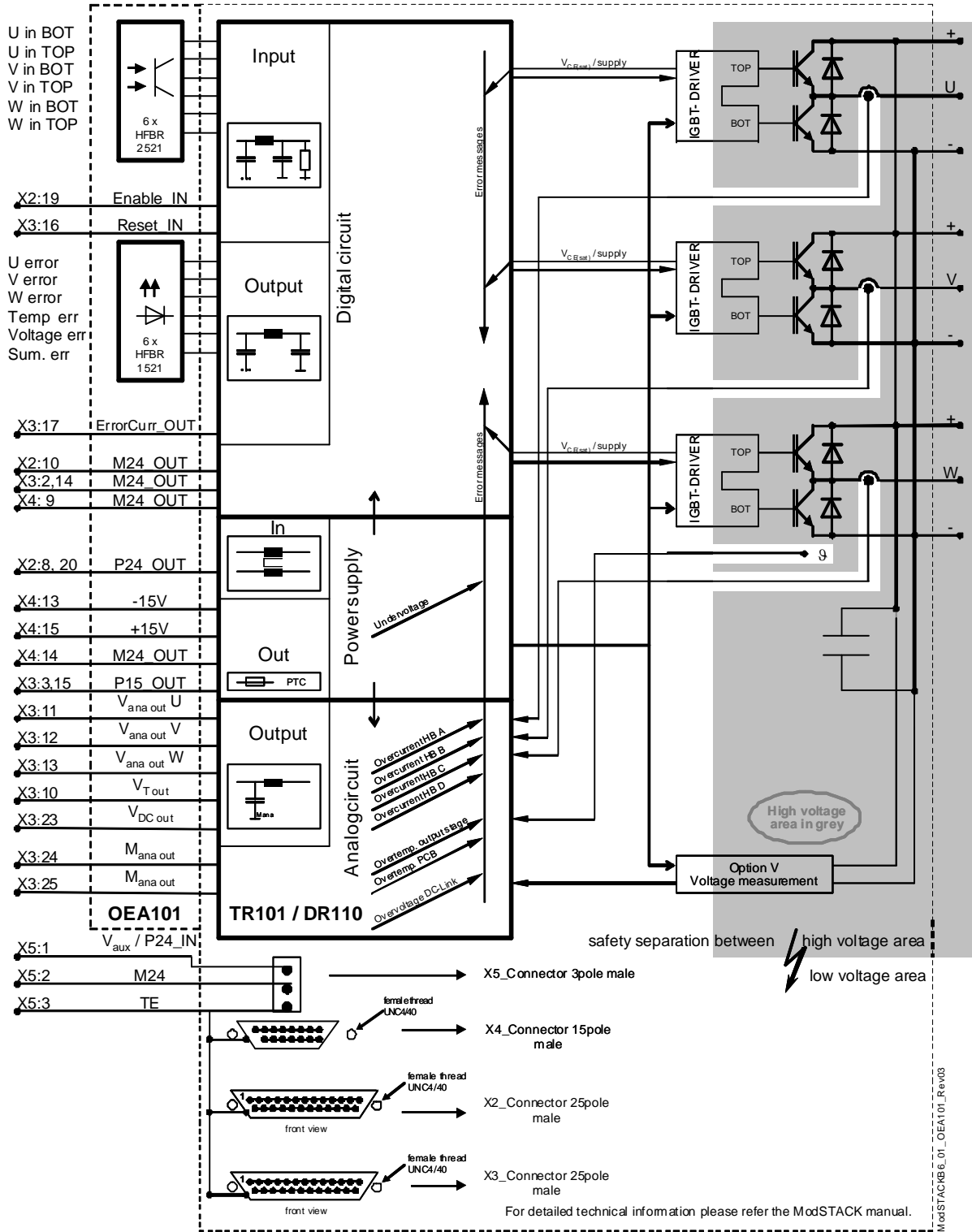
Vorläufige Daten  
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Transient thermal impedance per module  
 $T_{cool\ medium} = 40^{\circ}C$



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Circuit diagram



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- den Abschluss von speziellen Qualitätssicherungsvereinbarungen;
- die gemeinsame Einführung von Maßnahmen zu einer laufenden Produktbeobachtung dringend empfehlen und gegebenenfalls die Belieferung von der Umsetzung solcher Maßnahmen abhängig machen.

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Should you intend to use the Product in aviation applications, in health or live endangering or life support applications, please notify. Please note, that for any such applications we urgently recommend

- to perform joint Risk and Quality Assessments;
- the conclusion of Quality Agreements;
- to establish joint measures of an ongoing product survey, and that we may make delivery depended on the realization of any such measures.

If and to the extent necessary, please forward equivalent notices to your customers.

Changes of this product data sheet are reserved.

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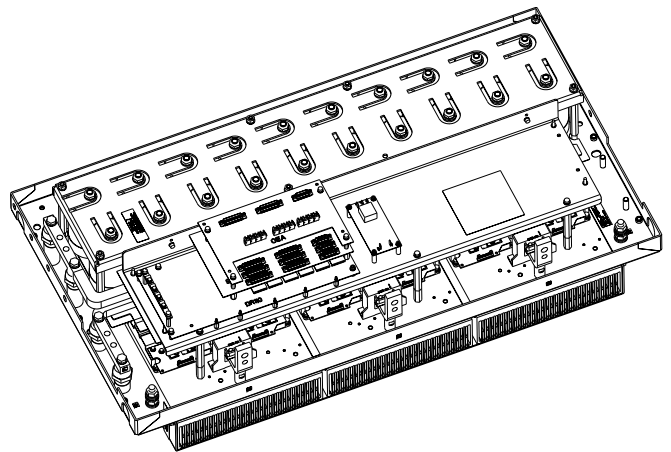
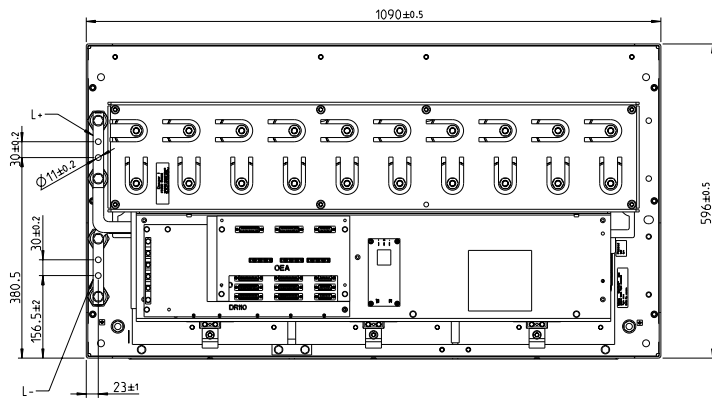
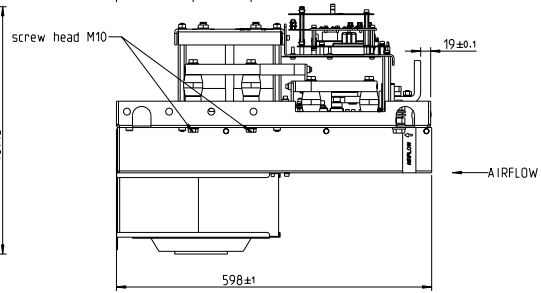
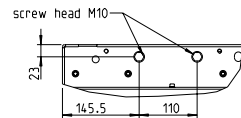
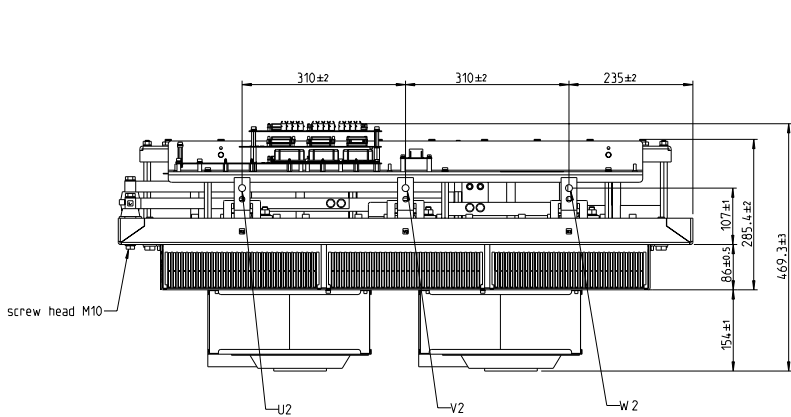
### **Sicherheitshinweise**

Bevor Sie mit der Installation und dem Betrieb der Baugruppe beginnen, lesen Sie bitte sorgfältig alle Sicherheitshinweise, Warnungen und beachten Sie die angebrachten Warnschilder. Vergewissern Sie sich, dass alle Warnschilder in leserlichem Zustand verbleiben und fehlende oder beschädigte Schilder ersetzt werden.

### **Safety Instructions**

Prior to installation and operation, all safety notices and warnings and all warning signs attached to the equipment have to be carefully read. Make sure that all warning signs remain in a legible condition and that missing or damaged signs are replaced. To installation and operation, all safety notices and warnings and all warning signs attached to the equipment have to be carefully read. Make sure that all warning signs remain in a legible condition and that missing or damaged signs are replaced.

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Part-No. 33878	general Tolerance Surface	Scale 1:5	
Assembly-No.		Material	
		Material-No.	
	Date Name	Description	
	Agent 23.06.09 Papenfert	6MS...-3F-C.....	
	Execut 23.06.09		
	Norm		
		Graph-No.	Version Sheet
		33878 Mb	0 Az
Ver.	Revision	Date	Name (Origin)

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